



N-Channel 250-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)		
250	0.435 at V _{GS} = 10 V	1.95		
	0.445 at V _{GS} = 6 V	1.9		

FEATURES

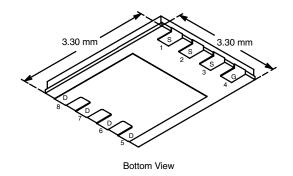
- PWM-Optimized TrenchFET® Power MOSFET
- Avalanche Tested
- 100 % R_q Tested



COMPLIANT

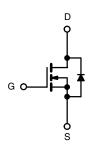
APPLICATIONS

- Primary Side Switch
- Small DC/DC Circuits
- Single-Ended Primary Switching Circuits



PowerPAK® 1212-8

Ordering Information: Si7802DN-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ess otherwise	noted			
Parameter		Symbol	10 sec	Steady State	Unit	
Drain-Source Voltage		V _{DS}	250		V	
Gate-Source Voltage		V_{GS}	± 20			
Out in the control of	T _A = 25 °C	- I _D	1.95	1.24		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		1.56	0.99		
Pulsed Drain Current		I _{DM}	8		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3		
Single Avalanche Current	1 0.1 mll	I _{AS}	2.5 0.3			
Single Avalanche Energy	L = 0.1 mH	E _{AS}			mJ	
	T _A = 25 °C	I D_	3.8	1.5	W	
Maximum Power Dissipation ^a	T _A = 70 °C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260		.0	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Manipulation to Applicate	t ≤ 10 sec	- R _{thJA}	26	33			
Maximum Junction-to-Ambient ^a	Steady State		65	81	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4			

- Notes:
 a. Surface Mounted on 1" x 1" FR4 Board.
 b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

 Pawork Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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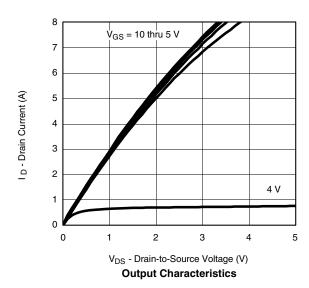
Parameter	Symbol	$T_J = 25$ °C, unless otherwise noted Symbol Test Conditions		Тур	Max	Unit	
Static			L	, ,,			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.4		3.6	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$			1		
		V _{DS} = 250 V, V _{GS} = 0 V, T _J = 55 °C			5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	8			Α	
	_	V _{GS} = 10 V, I _D = 1.95 A	0.360 0.43		0.435		
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 6 \text{ V}, I_D = 1.9 \text{ A}$		0.370	0.445	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 1.95 A		8		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Dynamic ^b				•			
Total Gate Charge	Q_g			14	21	nC	
Gate-Source Charge	Q_gs	$V_{DS} = 125 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1.95 \text{ A}$		2.8			
Gate-Drain Charge	Q_{gd}			4.4			
Gate Resistance	R_g	f = 1MHz		1.6	2.4	Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = 125 V, R_L = 1.25 Ω		10	15	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		21	35		
Fall Time	t _f			12	20		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.2 A, di/dt = 100 A/μs		65	100		

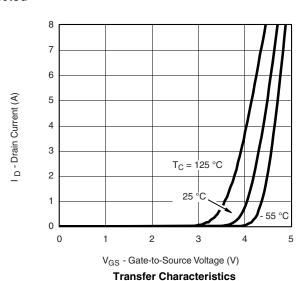
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



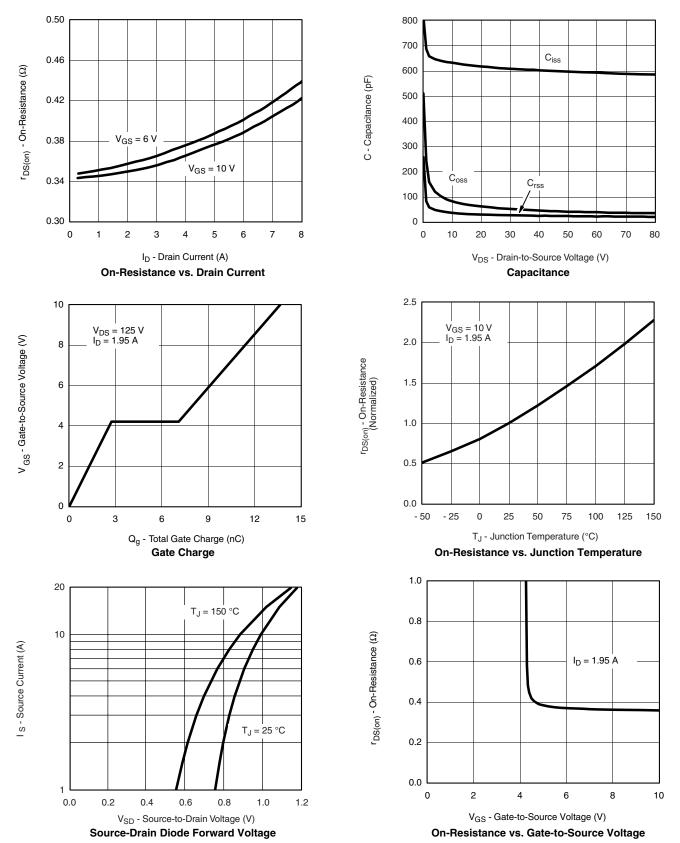








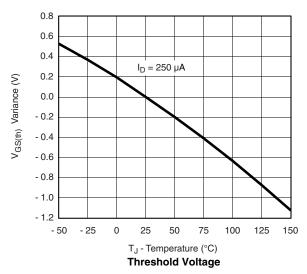
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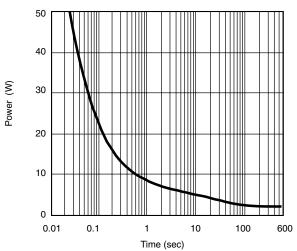


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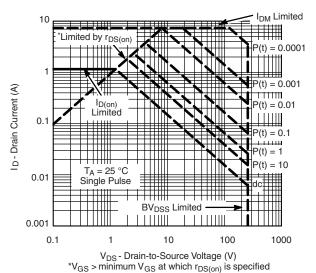
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

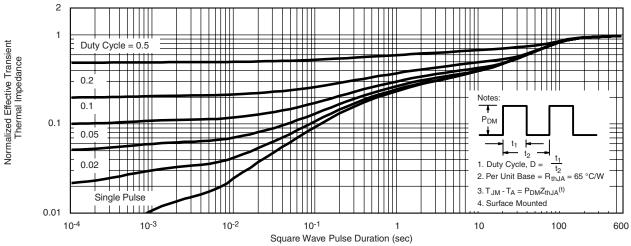




Single Pulse Power, Junction-to-Ambient



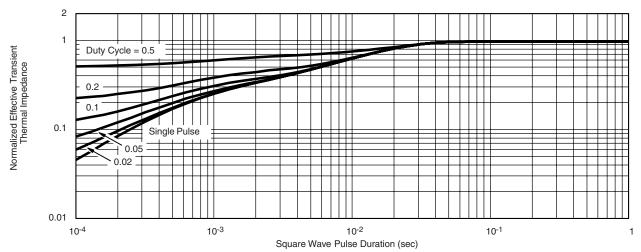
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73133.

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